SCLS195B - FEBRUARY 1993 - REVISED APRIL 1996

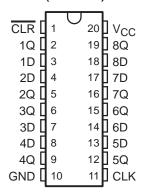
- EPIC™ (Enhanced-Performance Implanted CMOS) 2-μ Process
- Typical V<sub>OLP</sub> (Output Ground Bounce)
  < 0.8 V at V<sub>CC</sub>, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
  > 2 V at V<sub>CC</sub>, T<sub>A</sub> = 25°C
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), Ceramic Flat (W) Packages, Chip Carriers (FK), and (J) 300-mil DIPs

#### description

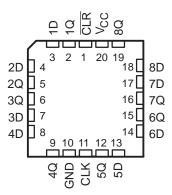
These octal D-type flip-flops are designed for 2.7-V to 5.5-V V<sub>CC</sub> operation.

The 'LV273 are positive-edge-triggered flip-flops with direct clear ( $\overline{\text{CLR}}$ ) input. Information at the data (D) inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock (CLK) input is at either the high or low level, the D-input signal has no effect at the output.

SN54LV273 . . . J OR W PACKAGE SN74LV273 . . . DB, DW, OR PW PACKAGE (TOP VIEW)



SN54LV273 . . . FK PACKAGE (TOP VIEW)



The SN74LV273 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54LV273 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LV273 is characterized for operation from –40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

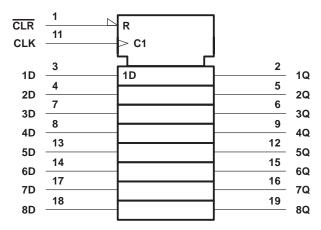
EPIC is a trademark of Texas Instruments Incorporated.



## FUNCTION TABLE (each flip-flop)

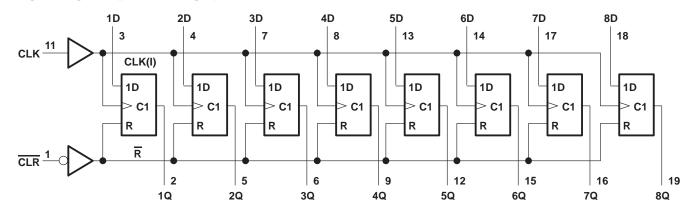
|     | INPUTS     | OUTPUT |       |
|-----|------------|--------|-------|
| CLR | CLK        | D      | Q     |
| L   | Х          | Χ      | L     |
| Н   | $\uparrow$ | Н      | Н     |
| Н   | $\uparrow$ | L      | L     |
| Н   | L          | Χ      | $Q_0$ |

### logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for DB, DW, J, PW, and W packages.

### logic diagram (positive logic)



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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>  | –0.5 V to 7 V                              |
|--|--|
| Input voltage range, V <sub>I</sub> (see Note 1)   | $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Output voltage range, V <sub>O</sub> (see Notes 1 and 2)                                 | $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )                            | ±20 mA                                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )                           | ±50 mA                                     |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )                               | ±25 mA                                     |
| Continuous current through V <sub>CC</sub> or GND  | ±50 mA                                     |
| Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 3): DB package | 0.6 W                                      |
| DW package .   | 1.6 W                                      |
| PW package   | 0.7 W                                      |
| Storage temperature range, T <sub>Sto</sub>  | –65°C to 150°C                             |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- 2. This value is limited to 7 V maximum.
- 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

### recommended operating conditions (see Note 4)

|   |  |  | SN54L | .V273 | SN74L | V273 |      |
|---|--|--|-------|-------|-------|------|------|
|   |  |  | MIN   | MAX   | MIN   | MAX  | UNIT |
| VCC                                     | Supply voltage                             |  | 2.7   | 5.5   | 2.7   | 5.5  | V    |
| \/                                      | V  | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2     |       | 2     |      |      |
| VIH                                     | High-level input voltage                   | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 3.15  |       | 3.15  |      | V    |
| V <sub>IL</sub> Low-level input voltage | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ |  | 0.8   |       | 0.8   | .,   |      |
|   | Low-level input voltage                    | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |       | 1.65  |       | 1.65 | V    |
| ٧ <sub>I</sub>                          | Input voltage                              |  |       |       | 0     | Vcc  | V    |
| Vo                                      | Output voltage                             |  | 0     | VCC   | 0     | VCC  | V    |
|   | I Pale I and a standard assessed           | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 20    | -6    |       | -6   | 0    |
| ЮН                                      | High-level output current                  | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 190   | -12   |       | -12  | mA   |
|   |  | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | Q     | 6     |       | 6    |      |
| lOL                                     | Low-level output current                   | V <sub>CC</sub> = 4.5 V to 5.5 V           |       | 12    |       | 12   | mA   |
| Δt/Δν                                   | Input transition rise or fall rate         |  |       |       | 0     | 100  | ns/V |
| T <sub>A</sub>                          | Operating free-air temperature             |  |       |       | -40   | 85   | °C   |

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| 24244555       | TEST CONDITIONS   |                       | ., +                | SN  | 154LV27 | 3                   | SN  | 74LV27 | 3    |      |
|----------------|---|-----------------------|---------------------|-----|---------|---------------------|-----|--------|------|------|
| PARAMETER      | TEST CONDITIO   | NS                    | v <sub>cc</sub> †   | MIN | TYP     | MAX                 | MIN | TYP    | MAX  | UNIT |
|                | I <sub>OH</sub> = -100 μA   | MIN to MAX            | V <sub>CC</sub> -0. | 2   |         | V <sub>CC</sub> -0. | 2   |        |      |      |
| VOH            | $I_{OH} = -6 \text{ mA}$  | 3 V                   | 2.4                 |     |         | 2.4                 |     |        | V    |      |
|                | I <sub>OH</sub> = -12 mA  | 4.5 V                 | 3.6                 |     |         | 3.6                 |     |        |      |      |
|                | I <sub>OL</sub> = 100 μA  |                       | MIN to MAX          |     |         | 0.2                 |     |        | 0.2  |      |
| VOL            | I <sub>OL</sub> = 6 mA  |                       | 3 V                 |     |         | 0.4                 |     |        | 0.4  | V    |
|                | I <sub>OL</sub> = 12 mA   |                       | 4.5 V               |     |         | 0.55                |     |        | 0.55 |      |
|                | $V_I = V_{CC}$ or GND   |                       | 3.6 V               |     | 1       | ±1                  |     |        | ±1   |      |
| l <sub>l</sub> |   |                       | 5.5 V               |     | 7EL     | ±1                  |     |        | ±1   | μΑ   |
| 1              | V V 0ND   |                       | 3.6 V               |     | 2       | ±5                  |     |        | ±5   |      |
| loz            | $V_O = V_{CC}$ or GND,  | IO = 0                | 5.5 V               |     | 9       | ±5                  |     |        | ±5   | μΑ   |
|                | V V OND   |                       | 3.6 V               | 80  | )       | 20                  |     |        | 20   |      |
| ICC            | $V_I = V_{CC}$ or GND,  | IO = 0                | 5.5 V               | Q'  |         | 20                  |     |        | 20   | μΑ   |
| ΔICC           | One input at V <sub>CC</sub> – 0.6 V,<br>Other inputs at V <sub>CC</sub> or GND |                       | 3 V to 3.6 V        |     |         | 500                 |     |        | 500  | μА   |
|                | V V 0ND   |                       | 3.3 V               |     | 2.5     |                     |     | 2.5    |      |      |
| Ci             | AI = ACC OL GND   | $V_I = V_{CC}$ or GND |                     |     | 3       |                     |     | 3      |      | pF   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

## timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

|                 |                            |                 |                        |       | SN54L             | V273  |       |       |      |
|-----------------|----------------------------|-----------------|------------------------|-------|-------------------|-------|-------|-------|------|
|                 |                            |                 | V <sub>CC</sub> = ± 0. |       | V <sub>CC</sub> = |       | VCC = | 2.7 V | UNIT |
|                 |                            |                 | MIN                    | MAX   | MIN               | MAX   | MIN   | MAX   |      |
| fclock          | Clock frequency            |                 | 0                      | 60    | . 0               | 50    | 0     | 40    | MHz  |
|                 | Dulas dunation             | CLR low         | 6                      | -01   | 10                |       | 12    |       |      |
| t <sub>w</sub>  | Pulse duration             | CLK high or low | 7                      | o Rio | 10                | S.P.O | 12    |       | ns   |
|                 |                            | Data            | 8                      | , bk  | 12                | , (   | 14    |       |      |
| t <sub>su</sub> | Setup time before CLK↑     | CLR inactive    | 2                      |       | 2                 |       | 2     |       | ns   |
| th              | Hold time, data after CLK↑ |                 | 3                      |       | 2                 |       | 2     |       | ns   |

## timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

|                 |                            |                 |     |                                    | SN74L | V273                               |     |                         |     |
|-----------------|----------------------------|-----------------|-----|------------------------------------|-------|------------------------------------|-----|-------------------------|-----|
|                 |                            |                 |     | V <sub>CC</sub> = 5.5 V<br>± 0.5 V |       | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 2.7 V |     |
|                 |                            |                 | MIN | MAX                                | MIN   | MAX                                | MIN | MAX                     |     |
| fclock          | Clock frequency            |                 | 0   | 60                                 | 0     | 50                                 | 0   | 40                      | MHz |
|                 |                            | CLR low         | 6   |                                    | 10    |                                    | 12  |                         |     |
| t <sub>W</sub>  | Pulse duration             | CLK high or low | 7   |                                    | 10    |                                    | 12  |                         | ns  |
|                 | Output the hadene OLICA    | Data            | 8   |                                    | 12    |                                    | 14  |                         |     |
| t <sub>su</sub> | Setup time before CLK↑     | CLR inactive    | 2   |                                    | 2     |                                    | 2   |                         | ns  |
| th              | Hold time, data after CLK↑ |                 | 3   |                                    | 2     |                                    | 2   |                         | ns  |

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# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

|                  |                 |                |                   |           |       | SN54L | .V273   |       |       |       |      |
|------------------|-----------------|----------------|-------------------|-----------|-------|-------|---------|-------|-------|-------|------|
| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> : | = 5 V ± ( | ).5 V | VCC = | 3.3 V ± | 0.3 V | VCC = | 2.7 V | UNIT |
|                  | (1141 01)       | (0011 01)      | MIN               | TYP       | MAX   | MIN   | TYP     | MAX   | _ MIN | MAX   |      |
| f <sub>max</sub> |                 |                | 60                | 100       |       | 50    | 80      | N     | 40    |       | MHz  |
| <sup>t</sup> pd  | CLK             | Q              |                   | 11        | 16    | WE.   | 16      | 22    | VIE   | 26    | ns   |
| t <sub>PHL</sub> | CLR             | Q              |                   | 13        | 22    |       | 14      | 24    |       | 30    | ns   |

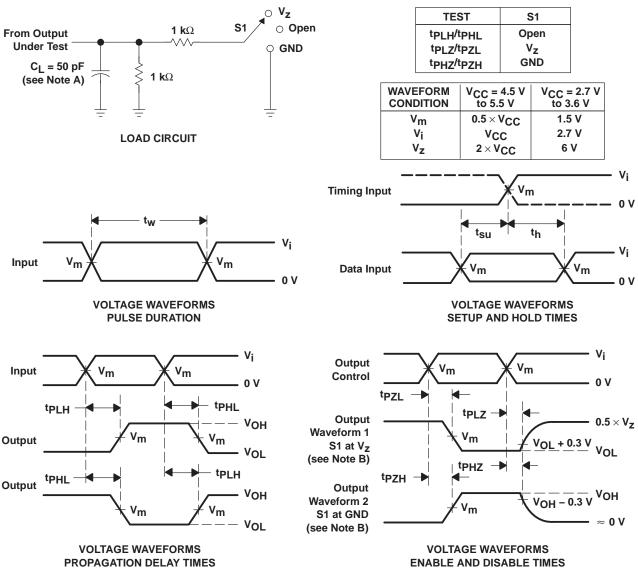
## switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

|                  |                 |                |                            |     |                              | SN74L | .V273 |                         |     |      |     |
|------------------|-----------------|----------------|----------------------------|-----|------------------------------|-------|-------|-------------------------|-----|------|-----|
| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CC}$ = 5 V $\pm$ 0.5 V |     | $V_{CC}$ = 3.3 V $\pm$ 0.3 V |       |       | V <sub>CC</sub> = 2.7 V |     | UNIT |     |
|                  | (INFOT)         | (001701)       | MIN                        | TYP | MAX                          | MIN   | TYP   | MAX                     | MIN | MAX  |     |
| f <sub>max</sub> |                 |                | 60                         | 100 |                              | 50    | 80    |                         | 40  |      | MHz |
| <sup>t</sup> pd  | CLK             | Q              |                            | 11  | 16                           |       | 16    | 22                      |     | 26   | ns  |
| <sup>t</sup> PHL | CLR             | Q              |                            | 13  | 22                           |       | 14    | 24                      |     | 30   | ns  |

### operating characteristics, $T_A = 25^{\circ}C$

|     | PARAMETER                                   | TEST CONDITIONS                    | VCC   | TYP | UNIT |
|-----|---|------------------------------------|-------|-----|------|
| Cod | Power dissipation capacitance per flip-flop | C <sub>1</sub> = 50 pF, f = 10 MHz | 3.3 V | 32  | pF   |
| Cpd | Tower dissipation capacitance per hip-hop   | CL = 50 pr, 1 = 10 MH2             | 5 V   | 41  | рі   |

#### PARAMETER MEASUREMENT INFORMATION



**INVERTING AND NONINVERTING OUTPUTS** 

LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \ \Omega$ ,  $t_f \leq 2.5 \ ns$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. tpLZ and tpHZ are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpl H and tpHI are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms







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#### PACKAGING INFORMATION

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins Package<br>Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|---------------------|-------------------------|------------------|------------------------------|
| SN74LV273DBLE    | OBSOLETE              | SSOP            | DB                 | 20                  | TBD                     | Call TI          | Call TI                      |
| SN74LV273DW      | OBSOLETE              | SOIC            | DW                 | 20                  | TBD                     | Call TI          | Call TI                      |
| SN74LV273DWR     | OBSOLETE              | SOIC            | DW                 | 20                  | TBD                     | Call TI          | Call TI                      |
| SN74LV273PWLE    | OBSOLETE              | TSSOP           | PW                 | 20                  | TBD                     | Call TI          | Call TI                      |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in

a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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